

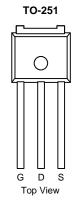
9563J-VB Datasheet P-Channel 40 V (D-S) MOSFET

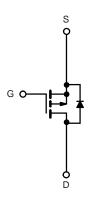
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a		
- 40	$0.010 \text{ at V}_{GS} = -10 \text{ V}$	± 55		
- 40	0.014 at V _{GS} = - 4.5 V	± 54		

FEATURES

• Compliant to RoHS Directive 2002/95/EC







P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
Parameter		Symbol	Limit	Unit		
Gate-Source Voltage		V _{GS}	± 40	V		
Continuous Drain Current (T. 175 °C)	T _C = 25 °C	,	- 55 ^a			
Continuous Drain Current (T _J = 175 °C)	T _C = 125 °C	I _D	- 52	\Box A		
Pulsed Drain Current	I _{DM}	- 220				
Avalanche Current		I _{AR}	- 60			
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	180	mJ		
Douger Dissipation	T _C = 25 °C	В	45	w		
Power Dissipation	T _A = 25 °C	P _D	3.75	VV		
Operating Junction and Storage Tempera	ture Range	T _J , T _{stq}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	PCB Mount (TO-263) ^c	В	40			
	Free Air (TO-220AB)	R _{thJA}	62.5	°C/W		
Junction-to-Case	•	R _{th.IC}	0.8			

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. When mounted on 1" square PCB (FR-4 material).
- d. See SOA curve for voltage derating.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS} $V_{GS} = 0 \text{ V, } I_{D} = -250 \mu\text{A}$		- 40			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0		- 2.5	1 V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = - 40 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 40 V, V _{GS} = 0 V, T _J = 125 °C			- 50	μA	
		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			- 250		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 120			Α	
		V _{GS} = - 10 V, I _D = - 30 A		0.010			
Drain-Source On-State Resistance ^a	D	V _{GS} = - 10 V, I _D = - 30 A, T _J = 125 °C		0.016		Ω	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 30 A, T _J = 175 °C		0.023			
		V _{GS} = - 4.5 V, I _D = - 20 A		0.014			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 75 A	20			S	
Dynamic ^b							
Input Capacitance	C _{iss}			3000		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$		620			
Reversen Transfer Capacitance	C _{rss}			315			
Total Gate Charge ^c	Qg			160			
Gate-Source Charge ^c	Q _{gs}	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 75 A		32		nC	
Gate-Drain Charge ^c	Q _{gd}			30		1	
Turn-On Delay Time ^c	t _{d(on)}			25	40		
Rise Time ^c	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 0.2 \Omega$		225	360	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -75 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 2.5 \Omega$		150	240		
Fall Time ^c	t _f			210	340	1	
Source-Drain Diode Ratings and Cha	racteristics ^b	(T _C = 25 °C)					
Continuous Current	I _S			- 220		۸	
Pulsed Current	I _{SM}				- 240	А	
Forward Voltage ^a	V_{SD}	I _F = -75 A, V _{GS} = 0 V		- 1.2	- 1.5	V	
Reverse Recovery Time	t _{rr}			55	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 75 A, dI/dt = 100 A/μs		2.5	5	Α	
Reverse Recovery Charge	Q _{rr}	-		0.07	0.25	μC	

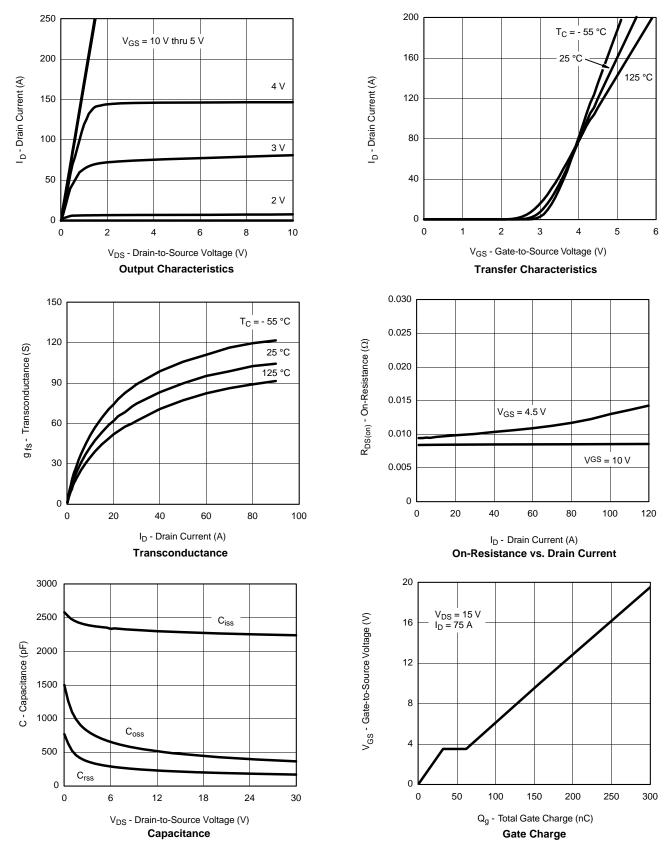
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

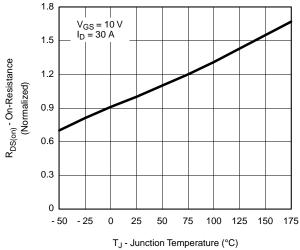


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

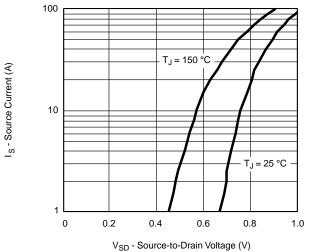




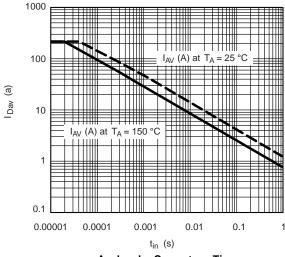
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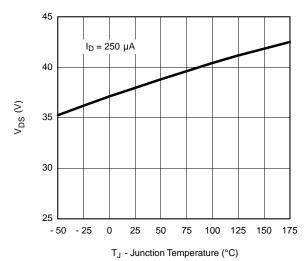
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



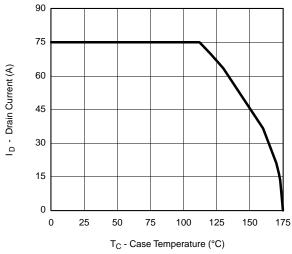
Avalanche Current vs. Time

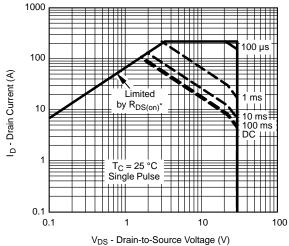


Drain Source Breakdown vs. Junction Temperature

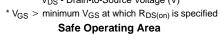


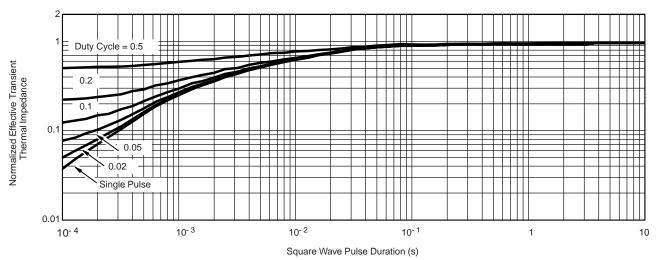
THERMAL RATINGS





Maximum Avalanche and Drain Current vs. Case Temperature





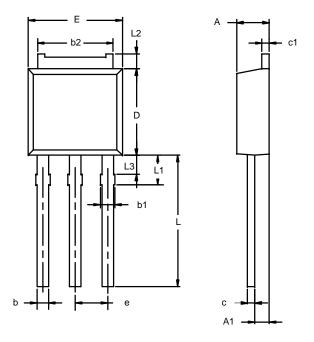
Normalized Thermal Transient Impedance, Junction-to-Case

服务热线:400-655-8788

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TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

	MILLIMETERS INCH			HES	
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
с1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090 BSC		
L	8.89	9.53	0.350	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	
ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346					



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